

# PE 300 / HD-PE

## POLYETHYLENE / HD-PE

### Material description

PE 300 is a semi-crystalline thermoplastic with a low molecular weight and therefore has a comparatively low density. This material has a markedly high-impact strength and breaking point when elongated. PE 300 is rather soft and has good damping properties. Other outstanding properties such as low moisture absorption, good chemical resistance and good insulating behaviour make PE 300 a versatile material.

### Conformities

RoHS, REACH

Physical properties	Test method	Value	Unit
Density	DIN EN ISO 1183-1	0.96	g/cm <sup>3</sup>
Water absorption	DIN EN ISO 62	<0.01	%
Sliding friction		●	
Abrasion resistance		◐	

Mechanical properties	Test method	Value	Unit
Yield stress	DIN EN ISO 527	25	MPa
Elongation at break	DIN EN ISO 527	>50	%
Tensile modulus of elasticity	DIN EN ISO 527	1200	MPa
Notched impact strength	DIN EN ISO 527	16	kJ/m <sup>2</sup>
Ball indentation hardness	DIN EN ISO 2039-1	43	MPa

Thermal properties	Test method	Value	Unit
Thermal conductivity	DIN 52612-2	0.38	W/(m*K)
Heat capacity	DIN 52612-1	1.9	kJ/(kg*K)
Coefficient of thermal expansion	DIN 53752	150-230	10 <sup>-6</sup> *K <sup>-1</sup>
Operating temperature short term		100	°C
Operating temperature long term		-50 bis 80	°C
Heat deflection temperature	DIN EN ISO 75 / A	49	°C
Flammability	UL 94, 3 mm	HB	

Electrical properties	Test method	Value	Unit
Volume resistivity	IEC 60093	10 <sup>14</sup>	Ω * cm
Surface resistivity	IEC 60093	10 <sup>14</sup>	Ω * cm
Dielectric strength	IEC 60243	45	kV/mm
Comparative tracking index (CTI)	IEC 60112	600	CTI

These technical data have been determined as average values by our suppliers from many individual measurements. In all measurements, the test specimens were tested in the dry state. We pass on the data with reservation. The table does not claim to be complete or correct. Material technology is subject to constant further development. No rights or guarantees can be derived from it. Own tests are necessary because the environmental and operating conditions (humidity, temperature, mechanical forces, radiation and chemicals, etc.) set limits in the application.